

October 17, 2024

IGI Report Number

Shape and Cutting Style

ADDITIONAL GRADING INFORMATION

Comments: As Grown - No indication of post-growth

This Laboratory Grown Diamond was created by High

Pressure High Temperature (HPHT) growth process.

Description

Measurements

Carat Weight

Color Grade

Clarity Grade

Fluorescence

Inscription(s)

treatment.

Type II

Cut Grade

Polish Symmetry

GRADING RESULTS

GEMOLOGICAL INSTITUTE

ELECTRONIC COPY

LABORATORY GROWN DIAMOND REPORT

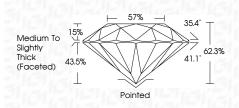
57% 35.4° Medium To 15% Slightly Thick (Faceted) 41 1° 43.5%

1691 LG659458809

Sample Image Used

October 17, 2024	
IGI Report Number	LG659458809
Description L	ABORATORY GROWN DIAMOND
Shape and Cutting Sty	e ROUND BRILLIANT
Measurements	7.38 - 7.42 X 4.61 MM
GRADING RESULTS	
Carat Weight	1.55 CARAT
Color Grade	D
Clarity Grade	VVS 2
Cut Grade	IDEAL

LABORATORY GROWN DIAMOND REPORT



ADDITIONAL GRADING INFORMATION

Polish	EXCELLENT		
Symmetry	EXCELLENT		
Fluorescence	NONE		
nscription(s)	(137) LG659458809		
Comments: As Grown - No indication of post-growth treatment. This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Type II			





PROPORTIONS

LG659458809

1.55 CARAT

D

VVS 2

IDEAL

EXCELLENT

EXCELLENT

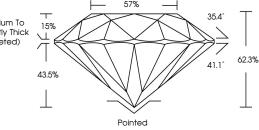
1/G1 LG659458809

NONE

ROUND BRILLIANT

7.38 - 7.42 X 4.61 MM

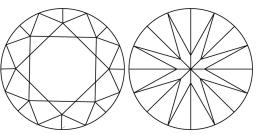
LABORATORY GROWN DIAMOND



LG659458809

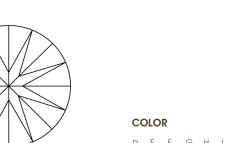
Report verification at igi.org

CLARITY CHARACTERISTICS



KEY TO SYMBOLS

Red symbols indicate internal characteristics. Green symbols indicate external characteristics.



DEEGH

DEF	GHIJ	Faint	Very Light	Light
CLARITY				
IF	VVS ^{1 - 2}	VS ¹⁻²	SI ¹⁻²	^{1 - 3}
Internally Flawless	Very Very Slightly Included	Very Slightly Included	Slightly Included	
		LITANSA LEI		

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